



## Manufacturing Metrology

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Deadline for manuscript  
submissions:

**closed (30 April 2021)**

### Message from the Guest Editors

This Special Issue welcomes papers revealing novel measurement methodologies and instrumentations for manufacturing metrology from conventional industry to the frontier of advanced hi-tech industry. We are proud to work with a team of skillful editorial assistants and highly efficient and experienced reviewers. Under our services, your research outcomes can be realized in the production of high-quality papers within a short time. Please submit your manuscripts related to, but not limited to, the following areas:

1. Precision dimensional measurements.
2. New technology or instruments for on-machine measurements.
3. In-process dimensional control or error compensation.
4. Machine tool metrology.
5. Robot metrology.
6. Strategic planning of manufacturing metrology.
7. Traceability, uncertainty analysis of measurement systems.

Manuscripts are expected to be submitted through the online system at <http://susy.mdpi.com>, choosing journal "Applied Sciences", Section "Mechanical Engineering" and Special Issue "Manufacturing Metrology". We look forward to receiving your papers.





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## Editor-in-Chief

**Prof. Dr. Giulio Nicola Cerullo**  
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## Message from the Editor-in-Chief

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